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(S) Curable silicone composition.

The present invention pertains to a curable silicone composition comprised of (A) an organopolysiloxane represented by the formula

$$(R^{2} - Sio_{1/2})_{a}(R^{3} - Sio_{1/2})_{b}(Sio_{4/2})_{c}$$

wherein RI is a monovalent hydrocarbon group other than an alkenyl group; R2 is a monovalent hydrocarbon group other than an alkenyl group or hydrogen; R3 is an organic group that contains an epoxy group or an alkoxyslykallyto group with the proviso that at least on R3 group is an organic group containing an epoxy group; a is either 0 or a positive number; b is a positive number; c is a positive number; a/c has a value of between 0.0 to 4, and (a + b)/c has a value of between 0.2 to 4; and (b) a curing compound selected from curing agents or curing catalysts.

The curable silicone composition of the present invention has superior curing properties and is capable of forming a hardened silicone material with superior flexibility and heat resistance after curing.

Because of their superior adhesive properties, bonding properties, environmental resistance, and electrical properties after the silicone is hardened curatele silicone compositions are used for electric and electronic fillers, adhesives for electric and electronic applications, coating compositions, and coating materials for rubber. Silicone compositions curable by a condensation-reaction which undergo curing by a dehydration-condenstion reaction of silanol groups, dehydrogenation between a silanol group and a hydrogen bonded to a silicon atom, dealcohol reaction between a silanol group and silicon atom bonded allowy group, and silicone compositions curable by an adduct reaction which undergo curing by an adduct reaction between the silicon atom, hydrogen and fattly acid unsaturated groups in the presence of hydrositivistion reaction catalvstars are known in the

However, in the silicone compositions curable by a condensation reaction, the curing requires a very long time and the curing property is interior; in the case of silicone compositions curable by an adduct reaction, curing does not progress in the presence of adduct reaction inhibitors such as sulfur and soldering flux, and the surface of the composition is less likely to be hardened because of oxygen. In addition, in general, the heat resistance of the curable silicone composition is inferior after curing.

76 This reason, various types of curable silicone compositions with Improved curing properties have been suggested. Curable silicone compositions comprised of a hydrolysate of an organic silane containing an epoxy group and ammonium perchiorate are disclosed in Japanese Kokai Patent Application No. Sho 56(1981)-72054 and curable silicone compositions comprised of an organopolysiloxane containing at least two epoxy groups in a single molecule, organopolysiloxane containing at least two epoxy groups in a single molecule, and an epoxy curing catalyst are disclosed in Japanese Kokai Patent Application No. Sho 60-198051-19417.

However, the curing properties of curable silicone compositions suggested in Japanese Kokai Patent Application No. Sho 56(1981)-72054 and Japanese Kokai Patent Application No. Sho 60(1985)-179417 are insufficient, and the flexibility and heat resistance of the cured silicone material are inferior.

It is an object of the present invention is to produce a curable silicone composition with superior curing properties that forms a hard silicone material with superior flexibility and heat resistance after curing.

The present invention pertains to a curable silicone composition comprised of (A) an organopolysiloxane represented by the formula

$$(R^{2} - Sio_{1/2})_{a}(R^{3} - Sio_{1/2})_{b}(Sio_{4/2})_{c}$$

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wherein R¹ is a monovalent hydrocarbon group other than an alkenyl group; R² is a monovalent hydrocarbon group other than an alkenyl group or hydrogen; R³ is a noganic group that contains an eyequ group or an alkoxysilylalkyl group with the provise that at least one R³ group is an organic group containing an egoxy group; as either 0 or a positive number; b is a positive number; c is a positive number; act has a value of between 0.05 to 4, and (a + b)c has a value of between 0.2 to 4; and (6) a curing catalysts.

The curable silicone composition of the instant invention is mainly comprised of an organopolysiloxane 45 made of monofunctional siloxane units (M units) and quaternary functional siloxane units (Q units) and has superior curing properties that forms a hardened silicone material with superior flexibility and heat resistance after curing.

The organopolysiloxane, component (A), is the primary component of the present invention and is represented by the formula:

$$\begin{array}{c} {}^{\rm R1} & {}^{\rm I} \\ ({}^{\rm I}^2 - {}^{\rm SiO}_{-{\rm SiO}_{1/2}})_{a} ({}^{\rm R}^3 - {}^{\rm SiO}_{1/2})_{b} ({}^{\rm SiO}_{4/2})_{c} \\ {}^{\rm I}_{1} & {}^{\rm I}_{1} \end{array}$$

is less than 0.1 part by weight per 100 parts by weight of component (A), the curing reaction is less likely to be initiated, and when the amount exceeds 500 parts by weight, a sufficient degree of the curing reaction fails to occur.

In addition, the curable silicone composition of the present invention which is mainly composed of component (d) and component (f) may include fillers such as aerosal elikar, crystalline alicar, lused silica, wet silica, titanium oxide, zinc carbonate, calcium carbonate, iron oxide, and carbon black, fatty acid esters such as stearic acid eater, and patriitic acid ester, metal satts, ester-based waxes, and plastification.

The curable silicone composition of the present invention has superior curing properties and forms a hard silicone material with a superior flexibility and heat resistance after curing. Therefore, it can be used 10 effectively for coating compositions, coating agents for electric and electronic parts, adhesives, sealers for electric and electronic parts, sealing agents for high temperature areas such as automobile engines, and for a composition that provides flexibility in the curable resin compositions.

So that those skilled in the art can understand and appreciate the invention taught herein, the following examples are presented.

In the following examples the value of the viscosity in application examples is the value measured at 25 °C, and curable elitione compositions were cured by heating at 150 °C for 3 hours Prothermore, measurement of physical properties of the hardened ellicone material was carried out as described below.

Heat resistance: A small piece of hardened silicone was heated in air at a rate of temperature increase of 10 °C/min by thermogravimetric analysis (TGA), and is shown as the

residual (wt%) at 850 °C.

Both ends of a hardened silicone material molded to form a 1/4 x 1/2 x 4 inch (0.835 x 1.27 x 10.16 centimeter) bar were fixed, then a 5 kg weight was hung from the center of the hardened silicone material, and the warding at the center area was

measured. When the warping was less than 0.5 cm, it is classified as x, when 0.5-cm, it is classified as x, when 0.5-cm, it is classified as 0.5 cm, it is classified as 0

1/10 inch (0.254 cm) was measured by a Barcot 935 hardness meter.

Preparation Example 1

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An organopolysiloxane shown by the formula

35 (viscosity 105 centipoise (k Pa.s), silicon-bonded hydrogen content 0.40 wt%) was reacted with an excess amount of allyl glycidyl ether in toluene using chloroplatinate as a catalyst. An organopolysiloxane having the formula.

$$\begin{array}{c} (\text{CH}_3)_3 \text{SiO}_{1/2} \big|_{0.8} (\text{CH}_3)_2 \big|_{0.7} \text{SiO}_{1/2} \big|_{0.7} (\text{SiO}_{4/2})_{1.0} \\ \text{C}_3 \text{H}_6 \text{OCH}_2 \text{CH-CH}_2 \\ \text{C}_3 \text{H}_6 \text{OCH}_2 \text{CH-CH}_2 \\ \end{array}$$

was produced. The viscosity of the organopolysiloxane produced was 520 centipoise (k Pa.s), and the epoxy equivalence was 420.

Preparation Example 2

An organopolysiloxane shown by the formula:

55 (viscosity 46 centipoise (k Pa.s), silicon-bonded hydrogen content 0.92 wt%) was reacted with an excess amount of allyl glycidyl ether in toluene with chloroplatinate as a catalyst. An organopolysiloxane having the formula:

$$\begin{array}{c} (\text{CH}_3)_2^{\text{Sio}}_{1/2}|_{1.8}^{(\text{Sio}}_{4/2})_{1.0} \\ \text{$^{\text{C}_3\text{H}}_6^{\text{OCH}}_2^{\text{CH-CH}}_2}_{0} \end{array}$$

was produced. The viscosity of the organopolysiloxane produced was 610 centipoise (k Pa.s), and the epoxy equivalence was 370.

Preparation Example 3

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A viscous organopolysiloxane shown by the formula

15 [(CH₃)₃SiO_{1/2}]_{0.7}[(CH₃)₂HSiO_{1/2}]_{0.5}(SiO_{4/2})_{1.0}

(silicon-bonded hydrogen content 0.33 wt%) was reacted in toluene with an excess amount of allyl glycidyl ether with chloroplatinate as a catalyst. An organopolysiloxane having the formula:

was produced. The organopolysiloxane produced had a semitransparent brown color, and the epoxy equivalence was 1100.

30 Preparation Example 4

An organopolysiloxane shown by the formula

[(CH₃)₃SiO_{1/2}]_{0.6}[(CH₃)₂HSiO_{1/2}]_{0.1}(SiO_{4/2})_{1.0}

(silicon-bonded hydrogen content 0.09 wt%) was reacted in toluene with an excess amount of allyl glycidyl ether with chloroplatinate as a catalyst. An organopolysiloxane having the formula

was produced. The organopolysiloxane produced had a semitransparent brown color, and the epoxy equivalence was 1290.

Preparation Example 5

An organopolysiloxane shown by the formula

(viscosity 46 centipoise (k Pa.s), silicon-bonded hydrogen content 0.92 wt%) was reacted in toluene with an excess amount of 1,2-epoxy-4- vinylcyclosiloxane with chloroplatinate as a catalyst. An organopolysiloxane having the formula

15 was produced. The organopolysiloxane produced had a semitransparent brown color, the viscosity was 520 centipoise (k Pa.s), and the epoxy equivalence was 230.

Preparation Example 6

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20 An organopolysiloxane shown by the formula

[(CH₃)₂HSiO_{1/2}]_{4,0}(SiO_{4/2})_{1,0}

(boiling point 190 °C, silicon-bonded hydrogen content 1.22 wt%) was reacted in toluene with an excess amount of allyl glycidyl ether with chloroplatinate as a catalyst, and organopolysiloxane having the formula:

$$(CH_3)_2 = \frac{1}{1} \frac{1}{4} \cdot 0 \cdot 0 \cdot 0 \cdot 0 \cdot 0$$
 $C_3 = \frac{1}{6} \cdot 0 \cdot 0 \cdot 0 \cdot 0 \cdot 0 \cdot 0$
 $C_3 = \frac{1}{6} \cdot 0 \cdot 0 \cdot 0 \cdot 0 \cdot 0 \cdot 0 \cdot 0$
(F)

below was produced. The organopolysiloxane produced was a semitransparent brown color, the viscosity was 54 centipoise (k Pa.s), and the epoxy equivalence was 205.

Preparation Example 7

An organopolysiloxane shown by the formula

(viscosity 46 centipoise, silicon-bonded hydrogen content 0.92 w1%) was reacted in toluene with a mixture composed of allyl glycidyl ether and allyltrimethoxysilane = 1:1 with chloroplatinate as a catalyst. An organocolvsiloxane having the formula

was produced. The organopolysiloxane produced had a semitransparent yellow color, and the viscosity was 200 centipoise (k Pa.s).

EXAMPLE 1

Organopolysiloxanes produced in the Preparation Examples, 3.4-epoxycyclohexylmethyl-3.4-epoxycyclohexane carboxylate, 3- or 4-methylhexahydrophthalic anhydride, and 2.4.6-(trisdimethylaminomethyl)-5 phenol were uniformly mixed in the weight ratio listed in Table I, and curable silicone compositions were produced. These curable silicone compositions were cured, and the properties of the hardened silicone materials were evaluated. These results are shown in Table I.

Also, the hardness of the curable silicone composition mixed with the organopolysiloxane prepared in Preparation Example 2 after curing was 55.

COMPARATIVE EXAMPLE 1

The organopolysiloxane was omitted, and a curable epoxy resin composition was prepared in the weight ratio shown in Table I. The curable epoxy resin composition was cured as in Example 1, and physical properties of the hardened material were evaluated. Results are shown in Table 1.

Also, the hardness of the hardened material was 55, and it was confirmed that no differences existed in the degree of hardness from the hardened material measured in Example 1.

Table I

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		Example 1				Comparative Example 1		
	Type of organopolysiloxane	Α	В	C/F	D/G	E	E	
25	Organopolysiloxane	100	100	95/5	95/5	100	50	-
	Α*	-	-	-	-	-	50	100
	B*	37.6	42.7	14.4	12.2	40.5	76.6	120.5
30	C*	1	1	1	1	1	1	1
	Flexibility	0	0	0	Δ	Δ	Δ	х
	Residual (wt%)	33	25	55	63	27	11	0

^{*}A: 3,4-Epoxycyclohexylmethy1-3,4-epoxycyclohexanecarboxylate

EXAMPLE 2

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In addition to the components of Example 1, a fused silica with an average grain diameter of 13 \(\varphi \) was added, and a curable silicone composition was produced as in Example 1. The curable silicone composition produced was cured as in Example 1, and the physical properties of the hardened silicone material were measured. Results are shown in Table II.

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B: 3- or 4-Methylhexahydrophthalic anhydride

C: 2,4,6-(Trisdimethylaminomethyl)phenol

Table II

	Example 2			
Type of organopolysiloxane	E	E		
Organopolysiloxane	100	50		
A*	-	50		
B*	40.5	76.6		
Fused silica	E 100	169.9		
C.	1	1		
Flexibility	Δ	Δ		
Residual (wt%)	65	57		

- *A: 3,4-Epoxycyclohexylmethyl-3,4-epoxycyclohexane carboxylate
- B: 3- or 4-Methylhexahydrophthalic anhydride
- C: 2.4.6-(Trisdimethylaminomethyl)phenol

COMPARATIVE EXAMPLE 2

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The same components as used in Example 1 were used except the organopolysiloxane shown in the following formula was used, and a curable silicone composition was produced as before. The organopolysiloxane shown in the formula below separated out onto the surface during curing of said curable silicone composition, and it was not possible to evaluate the physical properties of the material.

The curable silicone composition of the present invention is composed of component (A) and component (B). Component (A) is an organophysiloxane composed of monofunctional siloxane units (M units) containing an organic group containing an epoxy group and quaternary functional siloxane units (Q units). The curing properties of the silicone composition are superior, and a hardened silicone material having superior flexibility and heart esistance after curing can be obtained.

Claims

- A curable silicone composition comprised of
 (A) an organopolysiloxane represented by the formula
 - $(R^{2} Sio_{1/2})_{a} (R^{3} Sio_{1/2})_{b} (Sio_{4/2})_{c}$

wherein R¹ is a monovalent hydrocarbon group except R¹ is not an alkenyl group; R² is a monovalent hydrocarbon group except R² is not an alkenyl group or hydrogen; R² is selected from organic groups that contain an epoxy group or an alkoxysitylalkyl group with the proviso that at least one R² group is an organic group containing an epoxy group; a is either 0 or a positive number; b is a positive number; c is a positive number; a² chas a value of between 0 to 4, b/c has a value of between 0.05 to 4, and (a + b)/c has a value of between 0.25 to 4, and (B) a curinc comount selected from curins acents or curino catalysts.

- A composition as claimed in claim 1 wherein the curing agent (B) is selected from the group consisting or phenolic compounds, carboxylic acid compounds, acid anthyrides a mine compounds, compounds containing alkoxy groups, mixtures thereof and partial reaction products thereof.
 - A composition as claimed in claim 1 wherein the curing catalyst (B) is selected from the group consisting of tertilary amine compounds, quaternary amine compounds, phosphorus compounds, aluminum compounds. and zirconium compounds.
 - 4. A composition as claimed in claim 1 wherein there is 0.1 to 500 parts of (B) per 100 parts of (A).
 - 5. A composition as claimed in claim 1 wherein there is additionally a filler.

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- 6. A composition as claimed in claim 1 wherein there is additionally a ester based wax.
- 7. A composition as claimed in claim 1 wherein (B) is an organopolysiloxane represented by the formula

$$\begin{smallmatrix} [\; (\text{CH}_3)_3 \text{Sio}_{1/2} \end{smallmatrix}]_{0.8} \begin{smallmatrix} (\text{CH}_3)_2 \text{Sio}_{1/2} \end{smallmatrix}]_{0.7} \begin{smallmatrix} (\text{Sio}_{4/2})_{1.0} \\ \text{c}_3 \text{H}_6 \text{OCH}_2 \text{CH-CH}_2 \\ \text{c}_3 \end{smallmatrix}$$

8. A composition as claimed in claim 1 wherein (B) is an organopolysiloxane represented by the formula

9. A composition as claimed in claim 1 wherein (B) is an organopolysiloxane represented by the formula

10. A composition as claimed in claim 1 wherein (B) is an organopolysiloxane represented by the formula

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$$\begin{array}{c} \text{\{(CH_3)_3$} \text{sio}_{1/2} \\ \text{0.6} \\ \text{(CH_3)_2} \\ \text{sio}_{1/2} \\ \text{0.1} \\ \text{foot}_{2} \\ \text{OH}_{2} \\ \text{OC}_{2} \\ \text{COH}_{2} \\ \text{OC}_{2} \\ \text{O$$

10 11. A composition as claimed in claim 1 wherein (B) is an organopolysiloxane represented by the formula

$$\begin{array}{c|c} \text{(CH}_3)_2 \\ \text{C}_2 \\ \text{H}_4 \\ \hline \end{array}$$

12. A composition as claimed in claim 1 wherein (B) is an organopolysiloxane represented by the formula

13. A composition as claimed in claim 1 wherein (B) is an organopolysiloxane represented by the formula

$$\begin{smallmatrix} \{\text{(CH}_3)_2 \\ \text{c}_{3}^{\text{SiO}}_{1/2} \end{smallmatrix} \rbrace_{0.9} \begin{smallmatrix} \{\text{(CH}_3)_2 \\ \text{SiO}_{1/2} \end{smallmatrix} \rbrace_{0.9} \begin{smallmatrix} \text{(SiO}_{4/2} \\ \text{)}_{1.0} \end{smallmatrix} \\ \text{c}_{3}^{\text{H}_6} \\ \text{Si(OCH}_3)_3 \\ \text{c}_{3}^{\text{H}_6} \\ \text{OCH}_2 \\ \text{CH-CH}_2 \\ \text{CH-$$

14. A composition produced by curing the composition as claimed in claim 1.



EUROPEAN SEARCH REPORT

Application Numb

EP 93 10 8455 Page 1

	DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with of relevant p	indication, where appropriate,	Relevant to chaim	CLASSIFICATION OF THE APPLICATION (Int. CL5)
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x	* claims * * example 4 *	ND SILICONES LIMITED)	1-4, 12 14	
Y	* page 2, line 72 - * page 2, line 105	1ine 78 * - page 3, line 9 *	1-4,7-14	
P,Y	EP-A-0 541 988 (DOW COMPANY, LIMITED) * claim 1 * * page 5, line 29 - * examples *	CORNING TORAY SILICONE	1-4,7-14	TECHNICAL PRELDS
x	JOURNAL OF POLYMER CHEMISTRY EDITION vol. 28, no. 3, Feb pages 479 - 503, Y. Englet Cationic Polymerization, extended to the cationic Polymerization apage 481, paragrapa page 481, paragrapa page 483, conclusive page 503, conclusive page 503, conclusive page 486, paragrapa page 503, conclusive page 503,	ruary 1990, NEW YORK US PRODULISE E Synthesis, and Photoinitiated tion of Epoxy Resins. ph 2 * ph 3 * ions * -/	1,14	TRESPIRED (Mr. CLS) COBL. COBL. COBN. COS) COS)
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EUROPEAN SEARCH REPORT

Application Number

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Fine of smesh THE HAGUE 27 JULY CATEGORY OF CITED DOCUMENTS X particularly referred if combined with bandlers Y: predictable y referred if combined with bandlers A transmiss of the same confusery A transmiss of the same confusery C transmission before the confusery C transmission b			1993		HOLLENDER C.J.F		
			T: theory or principle underlying the invention E: entire principle underlying the invention E: entire principle underlying the published on, or after the filling side D: document often in the application L: document often in the application L: document other for other resones A: member of the same point family, corresponding				